

## **Application Data Sheet**

### **Application Information**

Application number::	Not Yet Assigned
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	SEMICONDUCTOR COMPONENT AND METHOD FOR PRODUCING SAME
Attorney Docket Number::	543822002200
Request for Early Publication?::	No
Request for Non-Publication?::	No
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

### **Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Germany
Status::	Full Capacity
Given Name::	Harry
Family Name::	HEDLER
City of Residence::	Germering
Country of Residence::	Germany
Street of mailing address::	Jahnstraße 8
City of mailing address::	Germering
Country of mailing address::	Germany
Postal or Zip Code of mailing address::	82110

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Germany  
Status:: Full Capacity  
Given Name:: Simon  
Family Name:: MUFF  
City of Residence:: Höhenkirchen  
Country of Residence:: Germany  
Street of mailing address:: Esterwagnerstraße 24  
City of mailing address:: Höhenkirchen  
Country of mailing address:: Germany  
Postal or Zip Code of mailing address:: 85635 ✓

**Correspondence Information**

Correspondence Customer Number:: 25227

**Representative Information**

Representative Customer Number:: 25227

**Foreign Priority Information**

Country::	Application number::	Filing Date::	Priority Claimed::
Germany	102 55 848.5	November 29, 2002	Yes

**Assignee Information**

Assignee name:: Infineon Technologies AG  
Street of mailing address:: St.-Martin Strasse 53  
City of mailing address:: München  
Country of mailing address:: Germany  
Postal or Zip Code of mailing address:: 81669